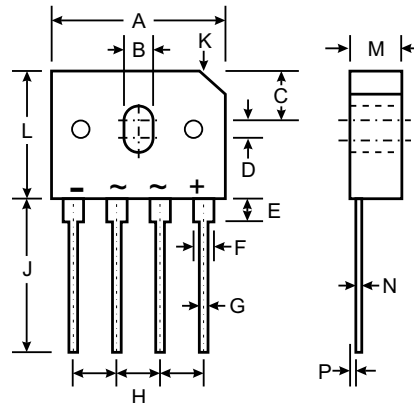


### Features

- Glass Passivated Die Construction
- High Case Dielectric Strength of 1500VRMS
- Low Reverse Leakage Current
- Surge Overload Rating to 175A Peak
- Ideal for Printed Circuit Board Applications
- Plastic Material: UL Flammability Classification Rating 94V-0
- UL Listed Under Recognized Component Index, File Number E94661

### Mechanical Data

- Case: Molded Plastic
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: Marked on Body
- Mounting: Through Hole for #6 Screw
- Mounting Torque: 5.0 Inch-pounds Maximum
- Marking: Date Code and Type Number
- Weight: 6.6 grams (approx.)



GBU		
Dim	Min	Max
A	21.8	22.3
B	3.5	4.1
C	7.4	7.9
D	1.65	2.16
E	2.25	2.75
G	1.02	1.27
H	4.83	5.33
J	17.5	18.0
K	3.2 X 45°	
L	18.3	18.8
M	3.30	3.56
N	0.46	0.56
P	0.76	1.0
All Dimensions in mm		

### Maximum Ratings and Electrical Characteristics @ T<sub>A</sub> = 25°C unless otherwise specified

Single phase, 60Hz, resistive or inductive load.  
 For capacitive load, derate current by 20%.

Characteristic	Symbol	GBU 6005	GBU 601	GBU 602	GBU 604	GBU 606	GBU 608	GBU 610	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	50	100	200	400	600	800	1000	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	35	70	140	280	420	560	700	V
Average Rectified Output Current (Note 1) @ T <sub>C</sub> = 100°C	I <sub>O</sub>	6.0							A
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I <sub>FSM</sub>	175							A
Forward Voltage (per element) @ I <sub>F</sub> = 3.0A	V <sub>FM</sub>	1.0							V
Peak Reverse Current @ T <sub>C</sub> = 25°C at Rated DC Blocking Voltage @ T <sub>C</sub> = 125°C	I <sub>R</sub>	5.0 500							μA
I <sup>2</sup> t Rating for Fusing (t < 8.3ms) (Note 2)	I <sup>2</sup> t	127							A <sup>2</sup> s
Typical Junction Capacitance per Element (Note 3)	C <sub>J</sub>	100							pF
Typical Thermal Resistance Junction to Case (Note 1)	R <sub>θJC</sub>	2.2							°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150							°C

Notes: 1. Unit mounted on 50mm x 50mm x 1.6mm copper plate heatsink.  
 2. Non-repetitive, for t > 1.0ms and < 8.3ms.  
 3. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.

